Sensors and Materials

Special Issue on Sensor for Society Call for Papers

The quality of industrial products is ensured by the sequential monitoring of the production process. To achieve a successful production process, sensing technology has been playing an important role. Various materials and sensing mechanisms have been developed to enable inline analysis where sensors are exposed to severe environmental conditions. The development of sensors and related technologies has also enabled us to fabricate biosensors including point-of-care testing device and wearable sensors for monitoring the vital status and disease diagnosis. Sensing technology has been meeting the social demand not only for industrial scene but also for human well-being to date. In this special issue, we are pleased to solicit reports on pioneering works that aim to collaborate with society in the field of sensing technology. The theme of the present issue includes an inline analysis system, physiological sensors, the development of probe molecules, and fundamental aspects of the sensing mechanism. We believe that this special issue will be a hub to accelerate our commitment to meeting the social demand with sensing technology.

Scope:

Optical sensors Data analysis for sensing

Thermal sensors Integration of remote sensing data and models

Microbial sensors Materials related to sensing system

Submission due date: August 31, 2023 **Publication date (planned):** January 2024

Journal website: https://sensors.myu-group.co.jp/

Guest Editors: Arinori Inagawa (Utsunomiya University), Yukiko Moriiwa (Tokyo University of

Pharmacy and Life Sciences), and Atsushi Shoji (Tokyo University of Pharmacy and Life

Sciences)

Submit to: Online Manuscript Submission System (https://myukk-org.ssl-xserver.jp/form/)

(Attention)

As stated in Instructions to Authors in the Guidelines, the author(s) will be obliged to pay the publication fee upon the acceptance of the manuscript for publication (for example, JPY 112200 for 10 pages in *Sensors and Materials* format). If the quality of the English of your manuscript does not satisfy the journal standards, the authors should bear the proofreading fee (JPY 10000–40000), which will be charged with the publication fee.

If you have any questions, please feel free to contact the editorial staff at the address below.

Editorial Department of *Sensors and Materials* MYU K.K.

1-23-3-303 Sendagi, Bunkyo-ku, Tokyo 113-0022, Japan

Tel: +81-3-3827-8549, Fax: +81-3-3827-8547

E-mail: myukk@myu-inc.jp

